

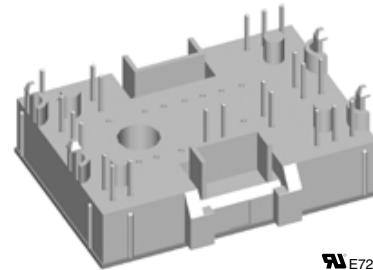
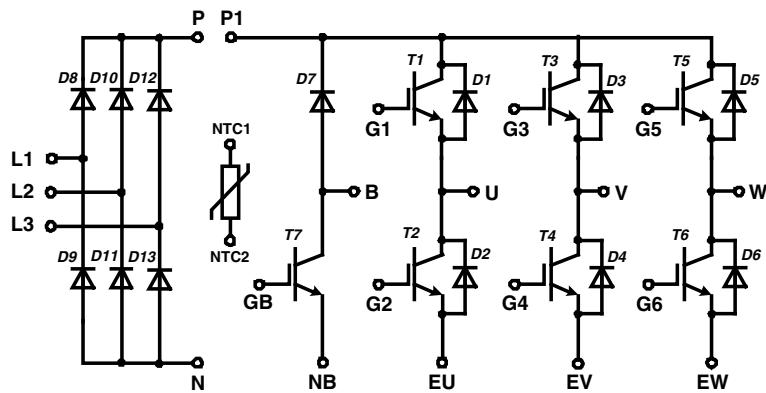
Converter - Brake - Inverter Module

Low Loss Trench IGBT

Three Phase Rectifier	Brake Chopper	Three Phase Inverter
$V_{RRM} = 1600 \text{ V}$	$V_{CES} = 1200 \text{ V}$	$V_{CES} = 1200 \text{ V}$
$I_{DAVM25} = 90 \text{ A}$	$I_{C25} = 17 \text{ A}$	$I_{C25} = 17 \text{ A}$
$I_{FSM} = 300 \text{ A}$	$V_{CE(sat)} = 1.9 \text{ V}$	$V_{CE(sat)} = 1.9 \text{ V}$

Part name (Marking on product)

MITB10WB1200TMH



E72873

Pin configuration see outlines.

Features:

- High level of integration - only one power semiconductor module required for the whole drive
- Inverter with low loss Trench IGBTs
 - very low saturation voltage
 - positive temperature coefficient
 - short tail current
- Epitaxial free wheeling diodes with hiperfast soft reverse recovery
- Temperature sense included

Application:

- AC motor drives
- Pumps, Fans
- Washing machines
- Air-conditioning system
- Inverter and power supplies

Package:

- "Mini" package
- Assembly height is 17 mm
- Insulated base plate
- Pins suitable for wave soldering and PCB mounting
- Assembly clips available
 - IXKU 5-505 screw clamp
 - IXRB 5-506 click clamp
- UL registered E72873

Output Inverter T1 - T6

Ratings						
Symbol	Definitions	Conditions	min.	typ.	max.	Unit
V_{CES}	collector emitter voltage		$T_{VJ} = 150^\circ\text{C}$		1200	V
V_{GES}	max. DC gate voltage				± 20	V
V_{GEM}	max. transient collector gate voltage	continuous transient			± 30	V
I_{C25}	collector current		$T_C = 25^\circ\text{C}$		17	A
I_{C80}			$T_C = 80^\circ\text{C}$		12	A
P_{tot}	total power dissipation		$T_C = 25^\circ\text{C}$		70	W
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 10 \text{ A}; V_{GE} = 15 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	1.9 2.3	2.2	V
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 0.3 \text{ A}; V_{GE} = V_{CE}$	$T_{VJ} = 25^\circ\text{C}$	5	5.5	V
I_{CES}	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$		0.6	mA
I_{GES}	gate emitter leakage current	$V_{GE} = \pm 20 \text{ V}$			150	nA
C_{ies}	input capacitance	$V_{CE} = 25 \text{ V}; V_{GE} = 0 \text{ V}; f = 1 \text{ MHz}$		600		pF
$Q_{G(on)}$	total gate charge	$V_{CE} = 600 \text{ V}; V_{GE} = 15 \text{ V}; I_C = 10 \text{ A}$		54		nC
$t_{d(on)}$ t_r $t_{d(off)}$ t_f E_{on} E_{off}	turn-on delay time current rise time turn-off delay time current fall time turn-on energy per pulse turn-off energy per pulse	inductive load $V_{CE} = 600 \text{ V}; I_C = 10 \text{ A}$ $V_{GE} = \pm 15 \text{ V}; R_G = 100 \Omega$	$T_{VJ} = 25^\circ\text{C}$	55 30 320 200 0.9 0.75		ns ns ns ns mJ mJ
$t_{d(on)}$ t_r $t_{d(off)}$ t_f E_{on} E_{off}	turn-on delay time current rise time turn-off delay time current fall time turn-on energy per pulse turn-off energy per pulse	inductive load $V_{CE} = 600 \text{ V}; I_C = 10 \text{ A}$ $V_{GE} = \pm 15 \text{ V}; R_G = 100 \Omega$	$T_{VJ} = 125^\circ\text{C}$	60 35 360 340 1.55 1.1		ns ns ns ns mJ mJ
RBSOA	reverse bias safe operating area	$V_{GE} = \pm 15 \text{ V}; R_G = 100 \Omega; I_C = 20 \text{ A}; T_{VJ} = 125^\circ\text{C}$	$V_{CEK} \leq V_{CES} \cdot d_i/dt$			V
I_{sc} (SCSOA)	short circuit safe operating area	$V_{CE} = 720 \text{ V}; V_{GE} = \pm 15 \text{ V}; R_G = 100 \Omega; t_p = 10 \mu\text{s}; \text{non-repetitive}$		40		A
R_{thJC} R_{thCH}	thermal resistance junction to case thermal resistance case to heatsink	(per IGBT)		0.65	1.9	K/W K/W

Output Inverter D1 - D6

Ratings						
Symbol	Definitions	Conditions	min.	typ.	max.	Unit
V_{RRM}	max. repetitive reverse voltage		$T_{VJ} = 150^\circ\text{C}$		1200	V
I_{F25}	forward current		$T_C = 25^\circ\text{C}$		24	A
I_{F80}			$T_C = 80^\circ\text{C}$		16	A
V_F	forward voltage	$I_F = 10 \text{ A}; V_{GE} = 0 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	2.0 1.6	2.4	V
Q_{rr} I_{RM} t_{rr} E_{rec}	reverse recovery charge max. reverse recovery current reverse recovery time reverse recovery energy	$V_R = 600 \text{ V}$ $di_F/dt = -300 \text{ A}/\mu\text{s}$ $I_F = 10 \text{ A}; V_{GE} = 0 \text{ V}$	$T_{VJ} = 125^\circ\text{C}$	1.9 12.8 335 0.54		μC A ns mJ
R_{thJC} R_{thCH}	thermal resistance junction to case thermal resistance case to heatsink	(per diode)		0.55	1.6	K/W K/W

 $T_C = 25^\circ\text{C}$ unless otherwise stated

IXYS reserves the right to change limits, test conditions and dimensions.

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Brake T7

Ratings						
Symbol	Definitions	Conditions	min.	typ.	max.	Unit
V_{CES}	collector emitter voltage		$T_{VJ} = 150^\circ\text{C}$		1200	V
V_{GES}	max. DC gate voltage				± 20	V
V_{GEM}	max. transient collector gate voltage	continuous transient			± 30	V
I_{C25}	collector current		$T_C = 25^\circ\text{C}$		17	A
I_{C80}			$T_C = 80^\circ\text{C}$		12	A
P_{tot}	total power dissipation		$T_C = 25^\circ\text{C}$		70	W
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 10 \text{ A}; V_{GE} = 15 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	1.9 2.3	2.2	V
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 0.3 \text{ A}; V_{GE} = V_{CE}$	$T_{VJ} = 25^\circ\text{C}$	5	5.5	V
I_{CES}	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$		0.6	mA
I_{GES}	gate emitter leakage current	$V_{GE} = \pm 20 \text{ V}$			150	nA
C_{ies}	input capacitance	$V_{CE} = 25 \text{ V}; V_{GE} = 0 \text{ V}; f = 1 \text{ MHz}$		600		pF
$Q_{G(on)}$	total gate charge	$V_{CE} = 600 \text{ V}; V_{GE} = 15 \text{ V}; I_C = 10 \text{ A}$		54		nC
$t_{d(on)}$	turn-on delay time	$V_{CE} = 600 \text{ V}; I_C = 10 \text{ A}$ $V_{GE} = \pm 15 \text{ V}; R_G = 100 \Omega$		55		ns
t_r	current rise time			30		ns
$t_{d(off)}$	turn-off delay time			320		ns
t_f	current fall time			200		ns
E_{on}	turn-on energy per pulse			0.9		mJ
E_{off}	turn-off energy per pulse			0.75		mJ
$t_{d(on)}$	turn-on delay time	$V_{CE} = 600 \text{ V}; I_C = 10 \text{ A}$ $V_{GE} = \pm 15 \text{ V}; R_G = 100 \Omega$		60		ns
t_r	current rise time			35		ns
$t_{d(off)}$	turn-off delay time			360		ns
t_f	current fall time			340		ns
E_{on}	turn-on energy per pulse			1.55		mJ
E_{off}	turn-off energy per pulse			1.1		mJ
RBSOA	reverse bias safe operating area	$V_{GE} = \pm 15 \text{ V}; R_G = 100 \Omega; I_C = 20 \text{ A}; T_{VJ} = 125^\circ\text{C}$	$V_{CEK} \leq V_{CES} \cdot d_t/dt$			V
I_{SC} (SCSOA)	short circuit safe operating area	$V_{CE} = 720 \text{ V}; V_{GE} = \pm 15 \text{ V}; R_G = 100 \Omega; t_p = 10 \mu\text{s}; \text{non-repetitive}$	$T_{VJ} = 125^\circ\text{C}$	40		A
R_{thJC}	thermal resistance junction to case	(per IGBT)			1.9	K/W
R_{thCH}	thermal resistance case to heatsink			0.65		K/W

Brake Chopper D7

Ratings						
Symbol	Definitions	Conditions	min.	typ.	max.	Unit
V_{RRM}	max. repetitive reverse voltage		$T_{VJ} = 150^\circ\text{C}$		1200	V
I_{F25}	forward current		$T_C = 25^\circ\text{C}$		15	A
I_{F80}			$T_C = 80^\circ\text{C}$		10	A
V_F	forward voltage	$I_F = 10 \text{ A}; V_{GE} = 0 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	2.5 2.0	3.1	V
I_R	reverse current	$V_R = V_{RRM}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$		0.1	mA
Q_{rr}	reverse recovery charge	$V_R = 600 \text{ V}$ $di_F/dt = tbd \text{ A}/\mu\text{s}$ $I_F = 10 \text{ A}; V_{GE} = 0 \text{ V}$		tbd		μC
I_{RM}	max. reverse recovery current			tbd		A
t_{rr}	reverse recovery time			tbd		ns
E_{rec}	reverse recovery energy			tbd		μJ
R_{thJC}	thermal resistance junction to case	(per diode)			2.5	K/W
R_{thCH}	thermal resistance case to heatsink			0.85		K/W

 $T_C = 25^\circ\text{C}$ unless otherwise stated

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Input Rectifier Bridge D8 - D11

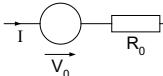
Ratings						
Symbol	Definitions	Conditions	min.	typ.	max.	Unit
V_{RRM}	max. repetitive reverse voltage	$T_{VJ} = 25^\circ\text{C}$		1600		V
I_{FAV}	average forward current	sine 180°	$T_C = 80^\circ\text{C}$	22		A
I_{DAVM}	max. average DC output current	rect.; $d = 1/3$	$T_C = 80^\circ\text{C}$	61		A
I_{FSM}	max. forward surge current	$t = 10 \text{ ms}; \text{sine } 50 \text{ Hz}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	300 tbd		A A
I^2t	I^2t value for fusing	$t = 10 \text{ ms}; \text{sine } 50 \text{ Hz}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	450 tbd		A ² s A ² s
P_{tot}	total power dissipation		$T_C = 25^\circ\text{C}$	50		W
V_F	forward voltage	$I_F = 30 \text{ A}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	1.35 1.35	1.6	V V
I_R	reverse current	$V_R = V_{RRM}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	0.01 0.3		mA mA
R_{thJC}	thermal resistance junction to case	(per diode)			2.1	K/W
R_{thCH}	thermal resistance case to heatsink	(per diode)		0.7		K/W

Temperature Sensor NTC

Ratings						
Symbol	Definitions	Conditions	min.	typ.	max.	Unit
R_{25}	resistance		$T_C = 25^\circ\text{C}$	4.75	5.0	kΩ
$B_{25/50}$				3375		K

Module

Ratings						
Symbol	Definitions	Conditions	min.	typ.	max.	Unit
T_{VJ}	operating temperature		-40		125	°C
T_{VJM}	max. virtual junction temperature				150	°C
T_{stg}	storage temperature		-40		125	°C
V_{ISOL}	isolation voltage	$I_{ISOL} \leq 1 \text{ mA}; 50/60 \text{ Hz}$			2500	V~
CTI	comparative tracking index				-	
F_C	mounting force		40		80	N
d_s	creep distance on surface			12.7		mm
d_A	strike distance through air			12		mm
Weight				35		g

Equivalent Circuits for Simulation

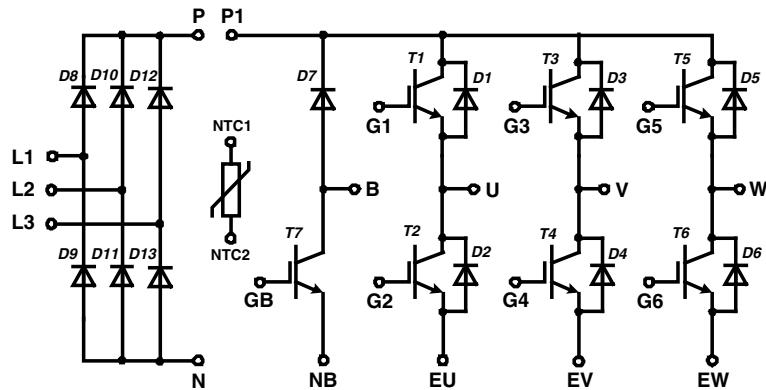
Ratings						
Symbol	Definitions	Conditions	min.	typ.	max.	Unit
V_0	rectifier diode	D8 - D13	$T_{VJ} = 125^\circ\text{C}$	0.9 16		V mΩ
R_0						
V_0	IGBT	T1 - T6	$T_{VJ} = 125^\circ\text{C}$	1.0 125		V mΩ
R_0						
V_0	free wheeling diode	D1 - D6	$T_{VJ} = 125^\circ\text{C}$	1.15 45		V mΩ
R_0						
V_0	IGBT	T7	$T_{VJ} = 125^\circ\text{C}$	1.0 125		V mΩ
R_0						
V_0	free wheeling diode	D7	$T_{VJ} = 125^\circ\text{C}$	1.4 60		V mΩ
R_0						

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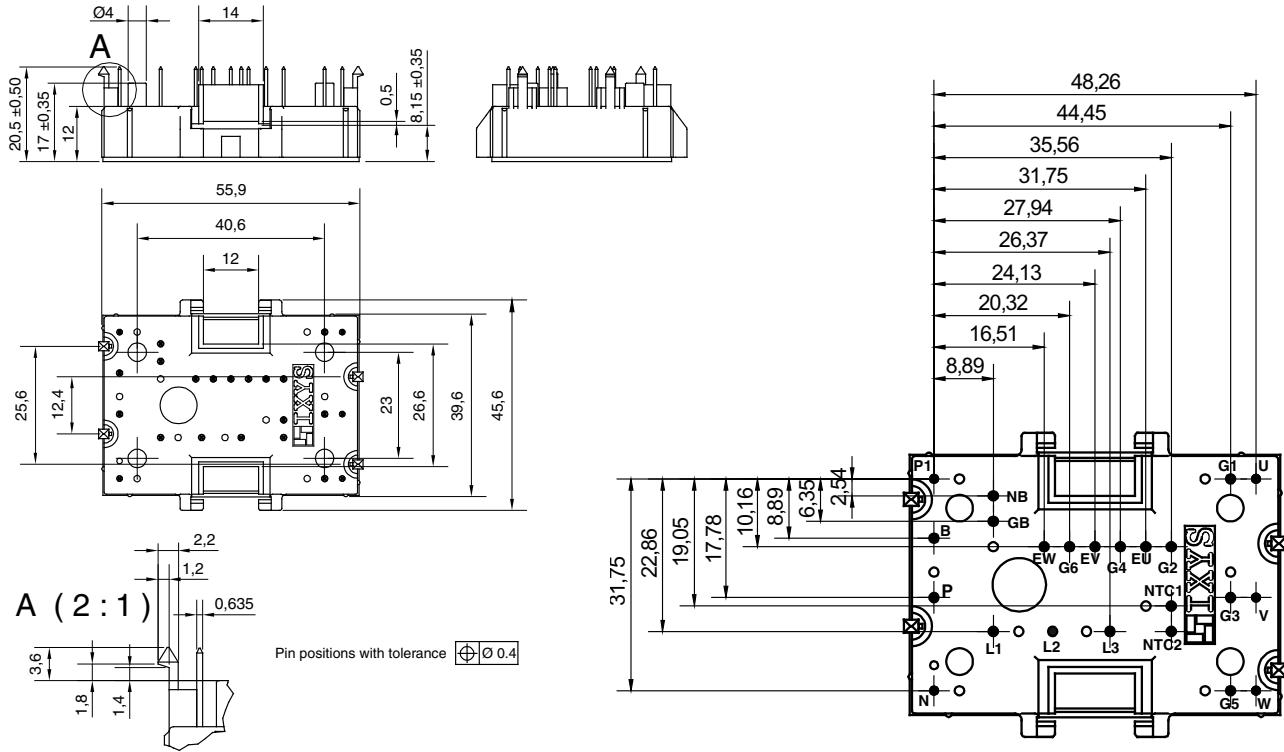
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Circuit Diagram

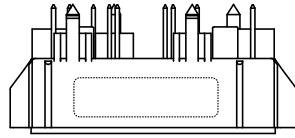


Outline Drawing

Dimensions in mm (1 mm = 0.0394")



Product Marking



Part number

- M = Module
- I = IGBT
- T = Trench
- B = Gen³ / low loss
- 10 = Current Rating [A]
- WB = 6-Pack + 3~ Rectifier Bridge & Brake Unit
- 1200 = Reverse Voltage [V]
- T = NTC
- MH = MiniPack2

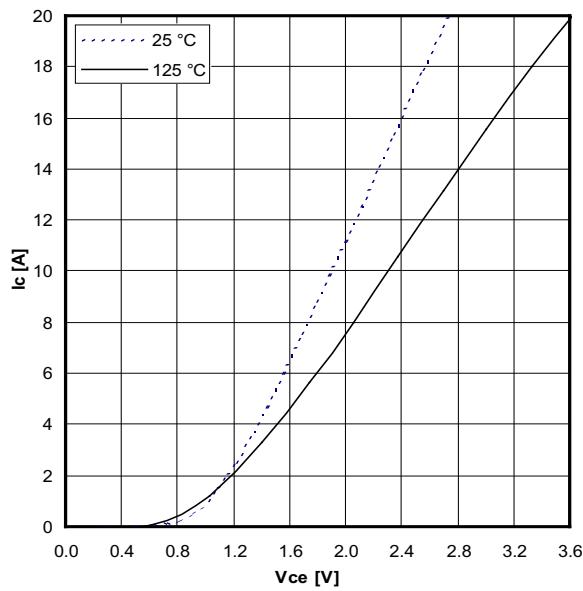
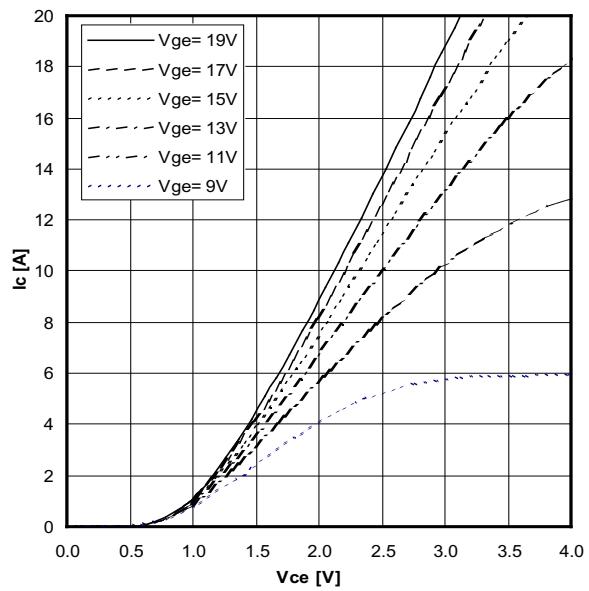
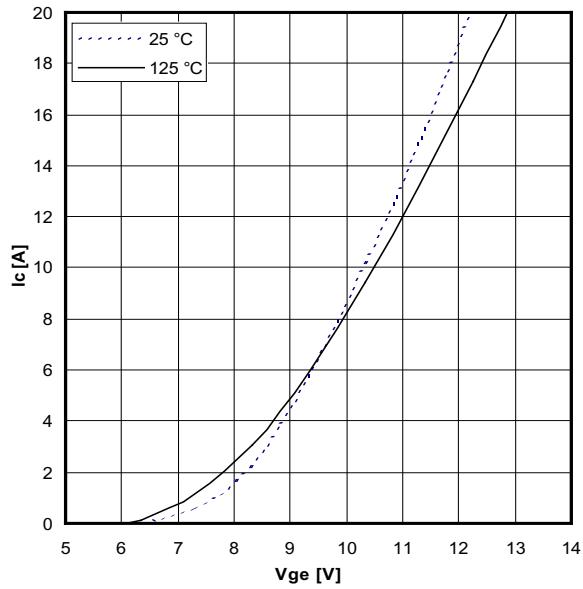
Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Ordering Code
Standard	MITB 10 WB 1200 TMH	MITB10WB1200TMH	Box	20	502722

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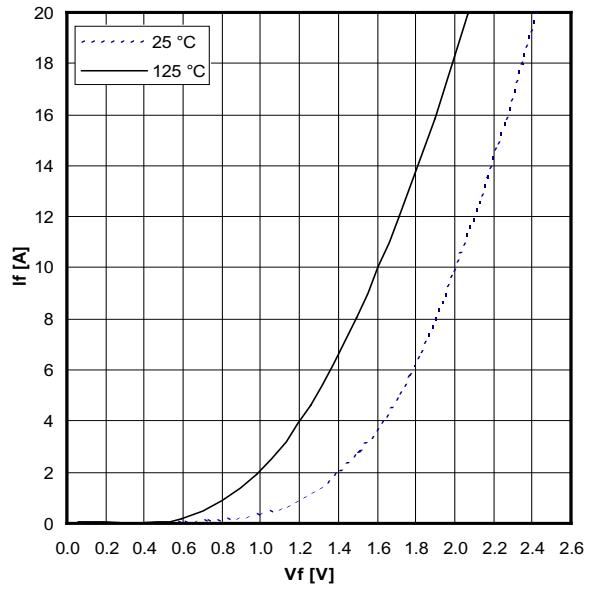
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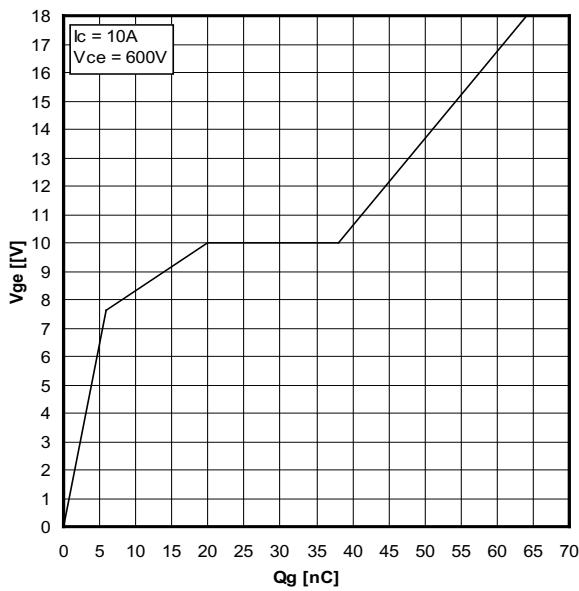
5 - 8

Typical output characteristics, $V_{GE} = 15\text{ V}$ Typical output characteristics (125°C)

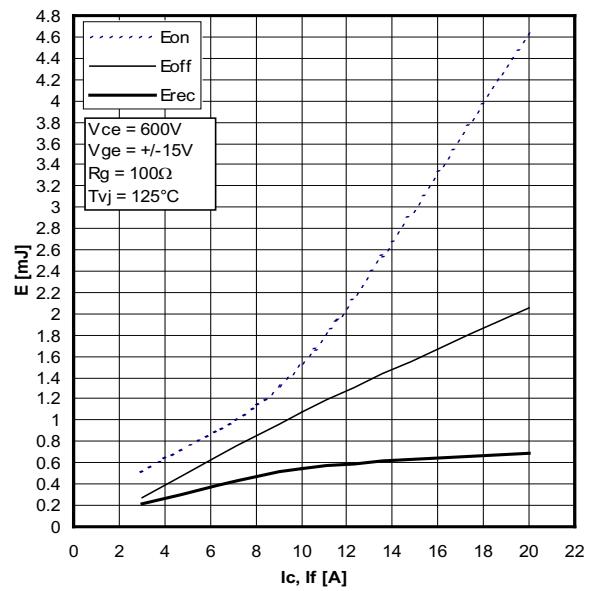
Typical transfer characteristics



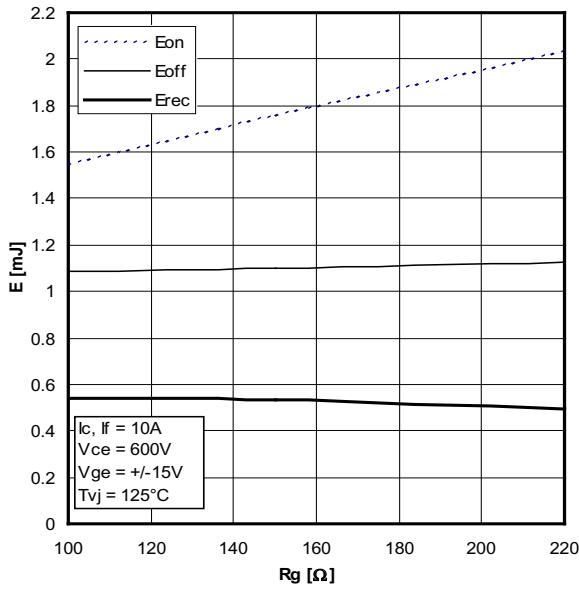
Typical forward characteristics of freewheeling diode



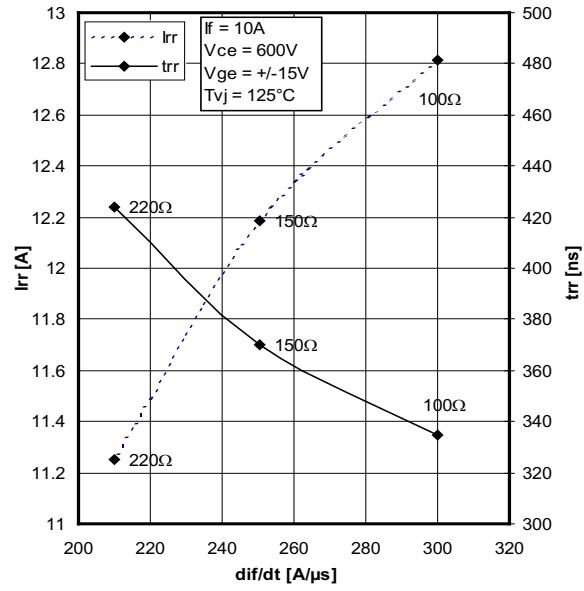
Typical turn on gate charge



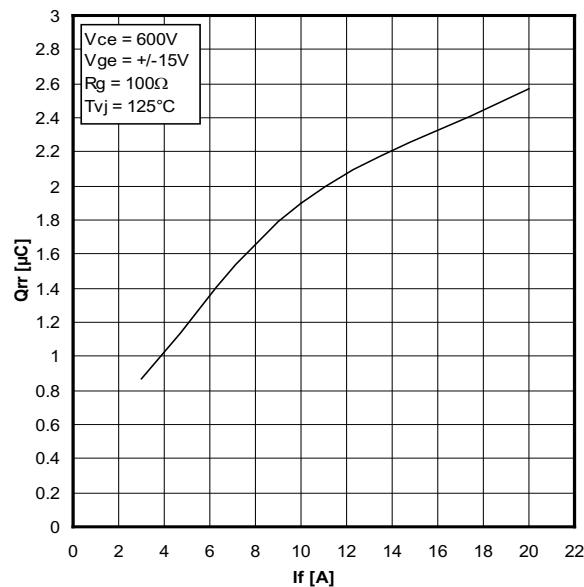
Typical switching energy versus collector current



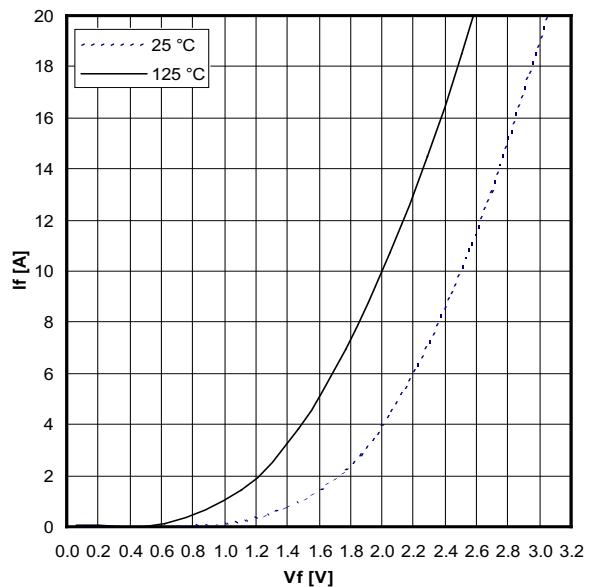
Typical switching energy versus gate resistance



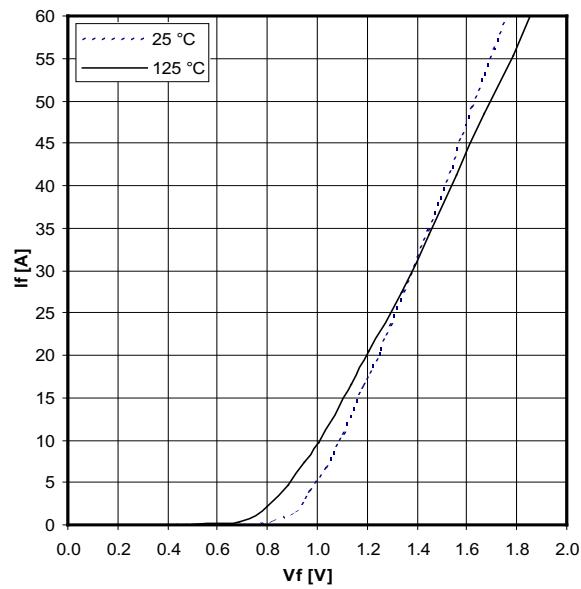
Typical turn-off characteristics of free wheeling diode



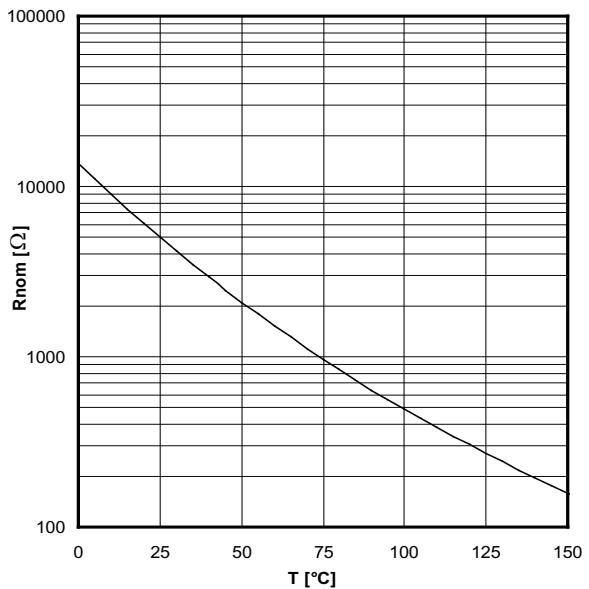
Typical turn-off characteristics of free wheeling diode



Typical forward characteristics of brake diode



Typical forward characteristics per rectifier



Typical thermistor resistance versus temperature